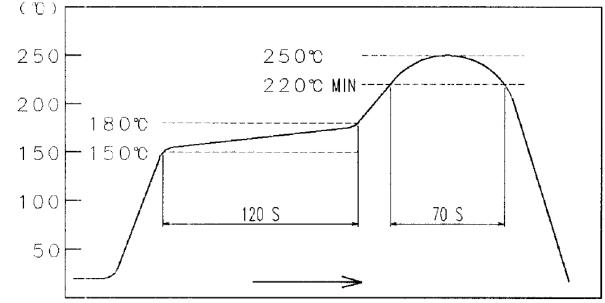
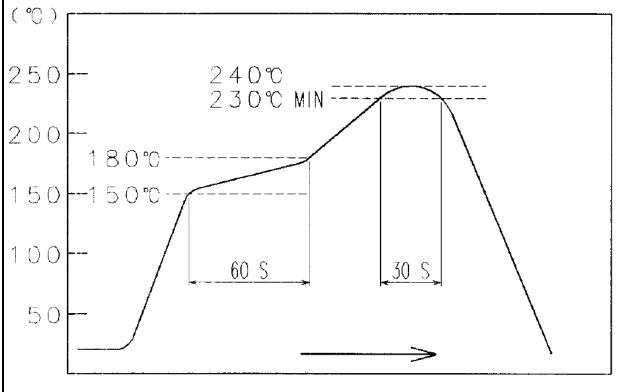
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INUITY OF10	Х	_
LOOSENESS	Х	_
INUITY OF10	Х	_
) mΩ MAX.		
(TERMINAL AREA) Δ. 2) INSULATION RESISTANCE: 1000 MΩ MIN. 3) NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		
 . 1) CONTACT RESISTANCE: 100 mΩ MAX. (TERMINAL AREA) Δ 2) INSULATION RESISTANCE: 10 MΩ MIN. 3) NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 		
NO HEAVY CORROSION.		
IOR S	Χ	_
SOLDERING POINT OF CONTACTS IMMERSION IN SLDER, 95 % MIN		
) (()	mΩ MAX. DOO MΩ MIN. DOSENESS MΩ MAX. D MΩ MIN. DOSENESS OR	MΩ MAX. 2000 MΩ MIN. 2000 MΩ MΩ M

FIG-1 SOLDERIMG HEAT RESISTANCE PROFILE(TEMPERATURE AT CONNECTOR SURFACE)

ATTACHMENT FIGURE



REFER TO FIG-2
FOR RECOMMENDED REFLOW TEMPERATURE PROFILE(TEMPERATURE AT SMT LEAD)



	Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWING NO.		ELC-124276-30-00						
	KS	SPECIFICATION SHEET	PART NO.	ST60X-18S (30)							
	11.0	HIROSE ELECTRIC CO., LTD.	CODE NO	CL024	1-0028-1-30	\triangle	2/2				
	EQDM 1100011 0 0										

FORM HD0011-2-2